Surface Mount **Monolithic Amplifier**

DC-1 GHz

Product Features

- Exact footprint substitute** MAR-8SM and MSA-0886
- High gain, 31.5 dB at 0.1GHz, reduces component count
- High power output, +12.5 dBm typ.
- Internally Matched to 50 Ohms
- Low noise
- Improved stability
- Protection against power supply transients
- Aqueous Washable
- Protected by US Patent, 6,943,629

Typical Applications

- Cellular
- PCN instrumentation



MAR-8ASM+

CASE STYLE: WW107 PRICE: \$1.17 ea. QTY. (30)

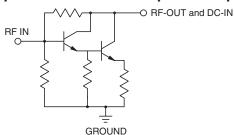
+ RoHS compliant in accordance with EU Directive (2002/95/EC)

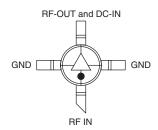
The +Suffix has been added in order to identify RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications.

General Description

MAR-8ASM+ (RoHS compliant) is a wideband amplifier offering high dynamic range. It has repeatable performance from lot to lot. It is enclosed in a Micro-X package. MAR-8ASM+ uses Darlington configuration and is fabricated using InGaP HBT technology. Expected MTBF is 14,000 years at 85°C case temperature.

simplified schematic and pin description





Function	Pin Number	Description	
RF IN	1	RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation.	
RF-OUT and DC-IN	3	RF output and bias pin. DC voltage is present on this pin; therefore a DC blocking capacitor is necessary for proper operation. An RF choke is needed to feed DC bias without loss of RF signal due to the bias connection, as shown in "Recommended Application Circuit".	
GND	2,4	Connections to ground. Use via holes as shown in "Suggested Layout for PCB Design" to reduce ground path inductance for best performance.	



For detailed performance spece & shopping online see web site

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Notes: 1. Performance and quality attributes and conditions not expressly stated in this specification sheet are intended to be excluded and do not form a part of this specification sheet. 2. Electrical specifications and performance data contained herein are based on Min-Circuit's applicable established test performance criteria and measurement instructions. 3. The parts covered by this specification sheet are subject to Mini-Circuit's applicable established test performance criteria and measurement instructions. 3. The parts covered by this specification sheet are subject to Mini-Circuit's standard Terms'); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms is provide the subject to Mini-Circuit's website at www.minicircuits.com/MCLStore/terms.jsp.

REV E



Electrical Specifications at 25°C and 36mA, unless noted

Parameter		Min.	Тур.	Max.	Units
Frequency Range*		DC		1	GHz
Gain	f=0.1 GHz f=1 GHz	20 ²	31.5 25		dB
Input Return Loss	f=DC to 1 GHz		15.5		dB
Output Return Loss	f=DC to 1 GHz		11		dB
Output Power @ 1 dB compression	f=1 GHz		+12.5		dBm
Output IP3	f=1 GHz		+25		dBm
Noise Figure	f=1 GHz		3.1		dB
Recommended Device Operating Current			36		mA
Device Operating Voltage			3.7		V
Device Voltage Variation vs. Temperature at 36 mA			+1.2		mV/°C
Device Voltage Variation vs. Current at 25°C			11.3		mV/mA
Thermal Resistance, junction-to-case ¹			140		°C/W

*Guaranteed specification DC-1 GHz. Low frequency cut off determined by external coupling capacitors.

Absolute Maximum Ratings

Parameter	Ratings	
Operating Temperature	-40°C to 85°C	
Storage Temperature	-55°C to 100°C	
Operating Current	65mA	
Power Dissipation	250mW	
Input Power	13dBm	

Note: Permanent damage may occur if any of these limits are exceeded. These ratings are not intended for continuous normal operation.

¹Case is defined as ground leads.

²Full temperature range.



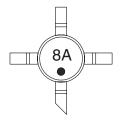
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Product Marking



Additional Detailed Technical Information

Additional information is available on our web site. To access this information enter the model number on our web site home page.

Performance data, graphs, s-parameter data set (.zip file)

Case Style: WW107

Plastic micro-x, .085 body diameter, lead finish: tin/silver/nickel

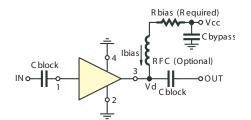
Tape & Reel: F4

Suggested Layout for PCB Design: PL-253

Evaluation Board: TB-411-8A+

Environmental Ratings: ENV08T3

Recommended Application Circuit



Test Board includes case, connectors, and components (in bold) soldered to PCB

R BIAS					
Vcc	"1%" Res. Values (ohms) for Optimum Biasing				
7	88.7				
8	118				
9	143				
10	174				
11	200				
12	226				
13	255				
14	280				
15	309				



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ESD Rating

Human Body Model (HBM): Class 2 (2000 v to < 4000 v) in accordance with ANSI/ESD STM 5.1 - 2001

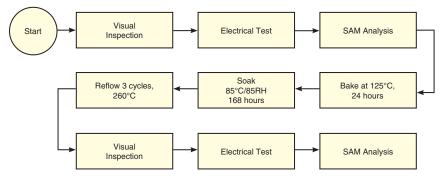
Machine Model (MM): Class M1 (<100 v) in accordance with ANSI/ESD STM 5.2 - 1999

MSL Rating

Moisture Sensitivity: MSL1 in accordance with IPC/JEDECJ-STD-020C

No.	Test Required	Condition	Standard	Quantity
1	Visual Inspection	Low Power Microscope Magnification 40x	MIP-IN-0003 (MCT spec)	45 units
2	Electrical Test	Room Temperature	SCD (MCL spec)	45 units
3	SAM Analysis	Less than 10% growth in term of delamination	J-Std-020C (Jedec Standard)	45 units
4	Moisture Sensitivity Level 1	Bake at 125°C for 24 hours Soak at 85°C/85%RH for 168 hours Reflow 3 cycles at 260°C peak	J-Std-020C (Jedec Standard)	45 units

MSL Test Flow Chart





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